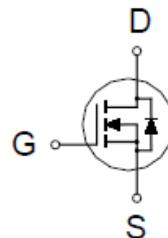
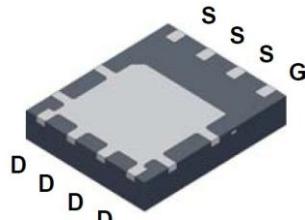


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N-Channel Enhancement Mode MOSFET

PRODUCT SUMMARY

$V_{(BR)DSS}$	$R_{DS(ON)}$	I_D
30V	11.8mΩ @ $V_{GS} = 10V$	39A



PDFN 5*6P

ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ C$ Unless Otherwise Noted)

PARAMETERS/TEST CONDITIONS		SYMBOL	LIMITS	UNITS
Drain-Source Voltage		V_{DS}	30	V
Gate-Source Voltage		V_{GS}	± 20	
Continuous Drain Current ³	$T_C = 25^\circ C$	I_D	39	A
	$T_C = 100^\circ C$		24	
	$T_A = 25^\circ C$		11	
	$T_A = 70^\circ C$		8	
Pulsed Drain Current ¹		I_{DM}	110	
Avalanche Current		I_{AS}	24	W
Avalanche Energy	$L = 0.1mH$	E_{AS}	30	
Power Dissipation	$T_C = 25^\circ C$	P_D	31	
	$T_C = 100^\circ C$		12	
	$T_A = 25^\circ C$		2.5	
	$T_A = 70^\circ C$		1.5	
Operating Junction & Storage Temperature Range		T_J, T_{STG}	-55 to 150	°C

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THERMAL RESISTANCE RATINGS

THERMAL RESISTANCE	SYMBOL	TYPICAL	MAXIMUM	UNITS
Junction-to-Case	$R_{\theta JC}$		4	
Junction-to-Ambient ²	$R_{\theta JA}$		50	°C / W

¹Pulse width limited by maximum junction temperature.

²The value of $R_{\theta JA}$ is measured with the device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with $T_A = 25^\circ C$. The value in any given application depends on the user's specific board design.

³Package limitation current is 35A.

ELECTRICAL CHARACTERISTICS ($T_J = 25^\circ C$, Unless Otherwise Noted)

PARAMETER	SYMBOL	TEST CONDITIONS	LIMITS			UNIT
			MIN	TYP	MAX	
STATIC						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS} = 0V, I_D = 250\mu A$	30			V
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250\mu A$	1.0	1.5	3.0	
Gate-Body Leakage	I_{GSS}	$V_{DS} = 0V, V_{GS} = \pm 20V$			± 100	nA
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS} = 24V, V_{GS} = 0V$			1	μA
		$V_{DS} = 20V, V_{GS} = 0V, T_J = 55^\circ C$			10	
Drain-Source On-State Resistance ¹	$R_{DS(ON)}$	$V_{GS} = 4.5V, I_D = 11A$		13	16.5	$m\Omega$
		$V_{GS} = 10V, I_D = 11A$		8.6	11.8	
Forward Transconductance ¹	g_{fs}	$V_{DS} = 5V, I_D = 11A$		25		S
DYNAMIC						
Input Capacitance	C_{iss}	$V_{GS} = 0V, V_{DS} = 15V, f = 1MHz$		1020		pF
Output Capacitance	C_{oss}			118		
Reverse Transfer Capacitance	C_{rss}			105		
Gate Resistance	R_g	$V_{GS} = 0V, V_{DS} = 0V, f = 1MHz$		1.6		Ω
Total Gate Charge ²	$Q_g(V_{GS}=10V)$	$V_{DS} = 0.5V_{(BR)DSS}, V_{GS} = 10V, I_D = 11A$		21		nC
	$Q_g(V_{GS}=4.5V)$			11		
Gate-Source Charge ²	Q_{gs}			4		
Gate-Drain Charge ²	Q_{gd}			5		
Turn-On Delay Time ²	$t_{d(on)}$	$V_{DS} = 15V, I_D \approx 11A, V_{GS} = 10V, R_{GEN} = 6\Omega$		18		nS
Rise Time ²	t_r			10		
Turn-Off Delay Time ²	$t_{d(off)}$			36		
Fall Time ²	t_f			10		



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SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS ($T_J = 25^\circ\text{C}$)						
Continuous Current ³	I_S				39	A
Diode Forward Voltage ¹	V_{SD}	$I_F = 11\text{A}, V_{GS} = 0\text{V}$			1.3	V
Reverse Recovery Time	t_{rr}	$I_F = 11\text{A}, dI_F/dt = 100\text{A} / \mu\text{s}$		13.4		nS
Reverse Recovery Charge	Q_{rr}			3.4		nC

¹Pulse test : Pulse Width $\leq 300\ \mu\text{sec}$, Duty Cycle $\leq 2\%$.

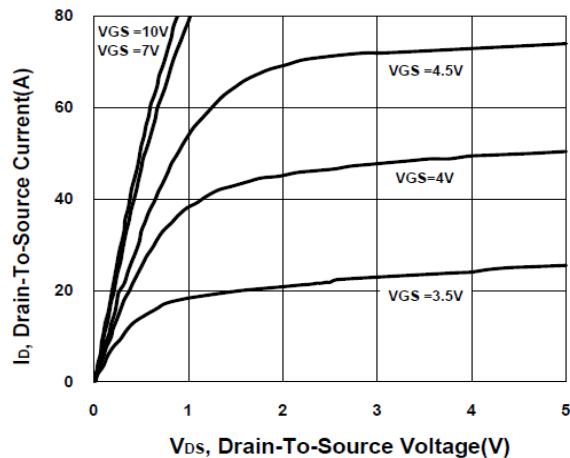
²Independent of operating temperature.

³Package limitation current is 35A.

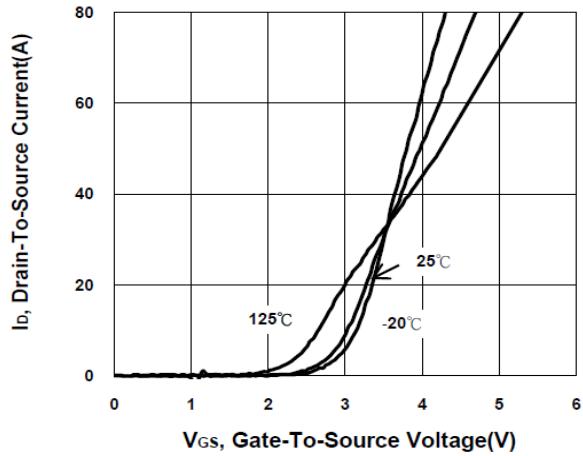
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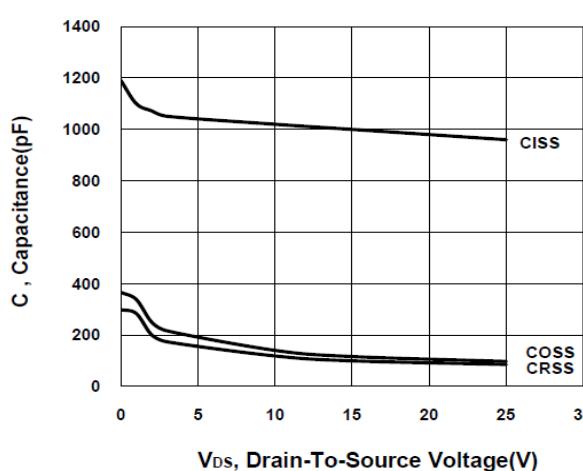
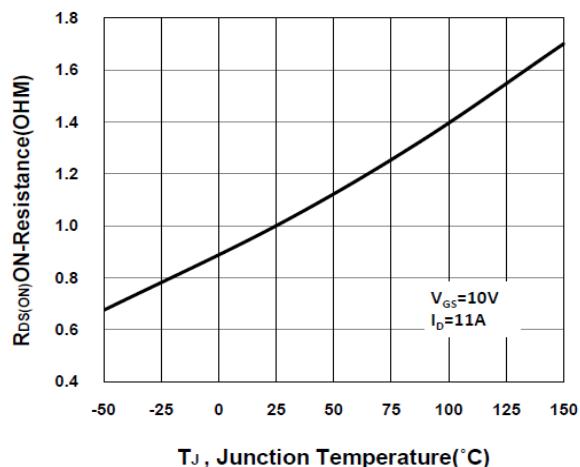
Output Characteristics



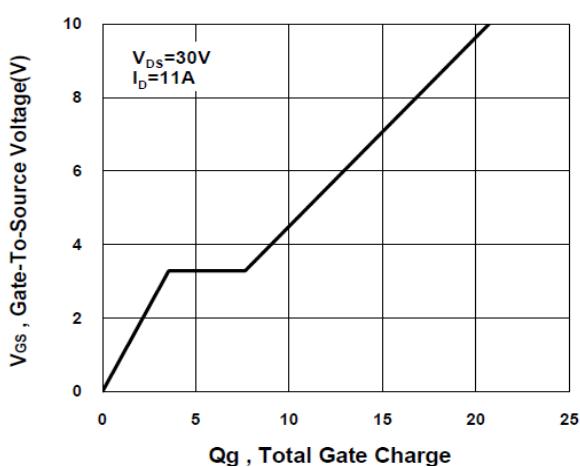
Transfer Characteristics



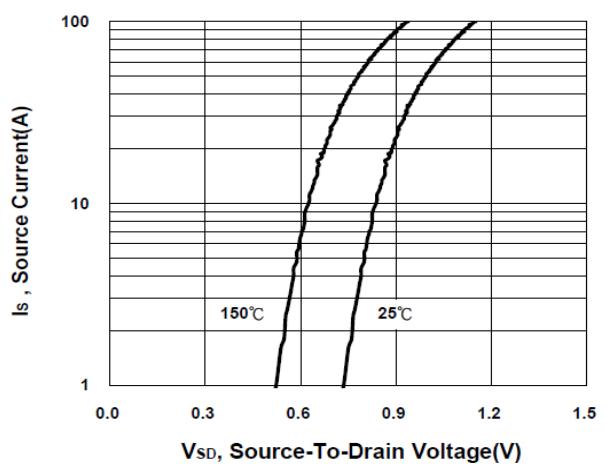
On-Resistance VS Temperature



Gate charge Characteristics

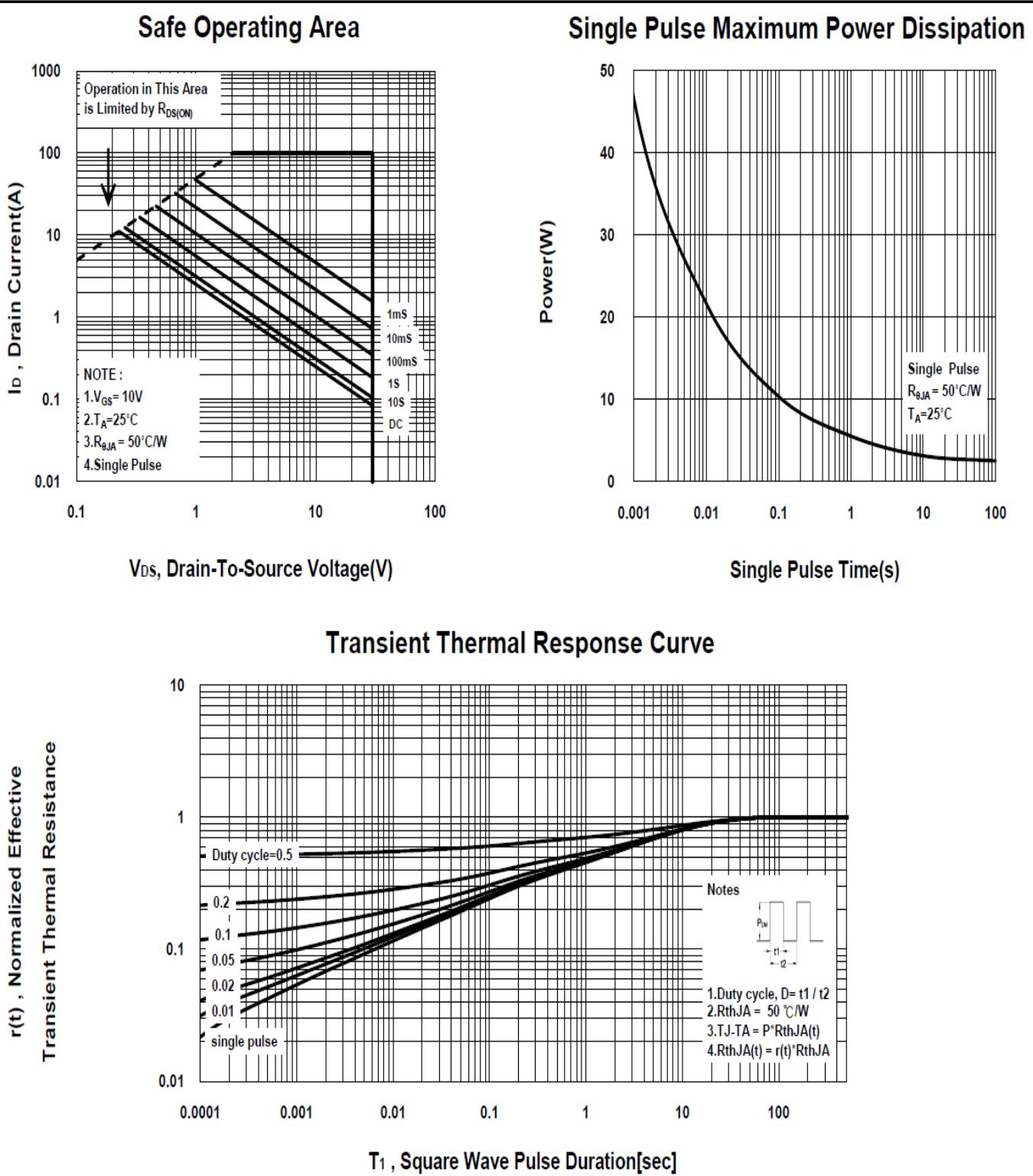


Source-Drain Diode Forward Voltage



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Package Dimension

PDFN 5x6P MECHANICAL DATA

Dimension	mm			Dimension	mm		
	Min.	Typ.	Max.		Min.	Typ.	Max.
A	4.8		5.15	J	3.33		3.78
B	5.44		5.9	K	0.9		
C	5.9		6.35	L	0.35		0.712
D	0.33		0.51	M	0°		12°
E		1.27		N	4.8		5.5
F	0.8		1.25	O	0.05		0.3
G	0.15		0.34	P	0.06		0.2
H	3.61		4.31	S	3.69		4.19
I	0.35		0.71				

